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# 120 mA, Current Sinking, 10-Bit, I<sup>2</sup>C ® DAC

# AD5821

### **FEATURES**

**120 mA current sink Available in 3 × 3 array WLCSP package 2-wire (I<sup>2</sup>C-compatible) 1.8 V serial interface 10-bit resolution Integrated current sense resistor 2.7 V to 5.5 V power supply Guaranteed monotonic over all codes Power-down to 0.5 µA typical Internal reference Ultralow noise preamplifier Power-down function Power-on reset** 

#### **CONSUMER APPLICATIONS**

**Lens autofocus Image stabilization Optical zoom Shutters Iris/exposure Neutral density (ND) filters Lens covers Camera phones Digital still cameras Camera modules Digital video cameras/camcorders Camera-enabled devices Security cameras Web/PC cameras** 

### **INDUSTRIAL APPLICATIONS**

**Heater controls Fan controls Cooler (Peltier) controls Solenoid controls Valve controls Linear actuator controls Light controls Current loop controls** 

### **GENERAL DESCRIPTION**

The AD5821 is a single 10-bit digital-to-analog converter with 120 mA output current sink capability. It features an internal reference and operates from a single 2.7 V to 5.5 V supply. The DAC is controlled via a 2-wire  $(I<sup>2</sup>C$ -compatible) serial interface that operates at clock rates up to 400 kHz.

The AD5821 incorporates a power-on reset circuit that ensures that the DAC output powers up to 0 V and remains there until a valid write takes place. It has a power-down feature that reduces the current consumption of the device to 1 μA maximum.

The AD5821 is designed for autofocus, image stabilization, and optical zoom applications in camera phones, digital still cameras, and camcorders.

The AD5821 also has many industrial applications, such as controlling temperature, light, and movement, over the range of −40°C to +85°C without derating.

The I<sup>2</sup>C address for the AD5821 is 0x18.



### **FUNCTIONAL BLOCK DIAGRAM**

#### **Rev. 0**

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### **REVISION HISTORY**

1/07-Revision 0: Initial Version

### <span id="page-2-0"></span>SPECIFICATIONS

 $V_{DD} = 2.7$  V to 5.5 V, AGND = DGND = 0 V, load resistance R<sub>L</sub> = 25  $\Omega$  connected to V<sub>DD</sub>; all specifications T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted.

### **Table 1.**

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1 Temperature range is as follows: B Version = −30°C to +85°C.

<sup>2</sup> Se[e](#page-9-1) the [Terminology](#page-9-1) section.

<sup>3</sup> Linearity is tested using a reduced code range: Code 32 to Code 1023.

4 To achieve near zero output current, use the power-down feature.

<sup>5</sup> Guaranteed by design and characterization; not production tested. XSHUTDOWN is active low. SDA and SCL pull-up resistors are tied to 1.8 V.<br><sup>6</sup> Input filtering on both the SCL and the SDA inputs suppresses noise spikes

### <span id="page-3-0"></span>**AC SPECIFICATIONS**

 $V_{DD}$  = 2.7 V to 5.5 V, AGND = DGND = 0 V, load resistance R<sub>L</sub> = 25  $\Omega$  connected to V<sub>DD</sub>, unless otherwise noted.

#### **Table 2.**



1 Temperature range is as follows: B Version = −40°C to +85°C.

<sup>2</sup> Guaranteed by design and characterization; not production tested.

<sup>3</sup> See the Terminology section.

### **TIMING SPECIFICATIONS**

 $\rm V_{\rm DD}$  = 2.7 V to 3.6 V. All specifications  $\rm T_{MIN}$  to  $\rm T_{MAX}$  unless otherwise noted.

**Table 3.** 



<sup>1</sup> Guaranteed by design and characterization; not production tested.

<sup>2</sup> A master device must provide a hold time of at least 300 ns for the SDA signal (referred to the VINH MIN of the SCL signal) to bridge the undefined region of the SCL falling edge.  $^3$  C<sub>B</sub> is the total capacitance of one bus line in pF. t<sub>R</sub> and t<sub>F</sub> are measured between 0.3 V<sub>DD</sub> and 0.7 V<sub>DD</sub>.

#### **Timing Diagram**



Figure 2. 2-Wire Serial Interface Timing Diagram

### <span id="page-4-0"></span>ABSOLUTE MAXIMUM RATINGS

 $T_A = 25$ °C, unless otherwise noted.

#### **Table 4.**



<sup>1</sup> To achieve the optimum  $\theta_{JA}$ , it is recommended that the AD5821

be soldered on a 4-layer board.

2 As per JEDEC J-STD-020C.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ESD CAUTION**



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

# <span id="page-5-0"></span>PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



Figure 3. 9-Ball WLCSP Pin Configuration

### **Table 5. 9-Ball WLCSP Pin Function Description**





Figure 4. Metallization Photo Dimensions shown in microns  $(\mu m)$ 

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### <span id="page-6-0"></span>TYPICAL PERFORMANCE CHARACTERISTICS

<span id="page-6-2"></span>Figure 7. ¼ to ¾ Scale Settling Time ( $V_{DD}$  = 3.6 V)



Figure 8. Settling Time for a 4-LSB Step ( $V_{DD} = 3.6$  V)



Figure 9. 0.1 Hz to 10 Hz Noise Plot ( $V_{DD}$  = 3.6 V)



Figure 10. Sink Current vs. Code vs. Temperature (V<sub>DD</sub> = 3.6 V)





Figure 12. INL vs. Temperature vs. Supply Voltage



Figure 13. DNL vs. Temperature vs. Supply Voltage



Figure 14. Zero-Code Error vs. Supply Voltage vs. Temperature







Supply Voltage and Temperature



Supply Voltage and Temperature



Figure 19. DNL vs. XSHUTDOWN Logic Low Level (VINL) vs. Supply Voltage and Temperature

### <span id="page-9-1"></span><span id="page-9-0"></span>**TERMINOLOGY**

### **Relative Accuracy**

For the DAC, relative accuracy or integral nonlinearity is a measurement of the maximum deviation, in LSB, from a straight line passing through the endpoints of the DAC transfer function. A typical INL vs. code plot is shown in [Figure 5](#page-6-1).

### **Differential Nonlinearity (DNL)**

Differential nonlinearity is the difference between the measured change and the ideal 1 LSB change between any two adjacent codes. A specified differential nonlinearity of ±1 LSB maximum ensures monotonicity. This DAC is guaranteed monotonic by design. A typical DNL vs. code plot is shown in [Figure 6](#page-6-2).

### **Zero-Code Error**

Zero-code error is a measurement of the output error when zero code (0x0000) is loaded to the DAC register. Ideally, the output is 0 mA. The zero-code error is always positive in the AD5821 because the output of the DAC cannot go below 0 mA. This is due to a combination of the offset errors in the DAC and output amplifier. Zero-code error is expressed in milliamperes (mA).

### **Gain Error**

Gain error is a measurement of the span error of the DAC. It is the deviation in slope of the DAC transfer characteristic from the ideal, expressed as a percent of the full-scale range.

### **Gain Error Drift**

Gain error drift is a measurement of the change in gain error with changes in temperature. It is expressed in LSB/°C.

### **Digital-to-Analog Glitch Impulse**

This is the impulse injected into the analog output when the input code in the DAC register changes state. It is normally specified as the area of the glitch in nanoamperes per second (nA-s) and is measured when the digital input code is changed by 1 LSB at the major carry transition.

### **Digital Feedthrough**

Digital feedthrough is a measurement of the impulse injected into the analog output of the DAC from the digital inputs of the DAC, but it is measured when the DAC output is not updated. It is specified in nanoamperes per second (nA-s) and measured with a full-scale code change on the data bus, that is, from all 0s to all 1s and vice versa.

### **Offset Error**

Offset error is a measurement of the difference between  $I_{\text{SINK}}$ (actual) and  $I<sub>OUT</sub>$  (ideal) in the linear region of the transfer function, expressed in milliamperes (mA). Offset error is measured on the AD5821 with Code 16 loaded into the DAC register.

### **Offset Error Drift**

Offset error drift is a measurement of the change in offset error with a change in temperature. It is expressed in microvolts per degree Celsius (μV/°C).

### <span id="page-10-0"></span>THEORY OF OPERATION

The AD5821 is a fully integrated, 10-bit digital-to-analog converter (DAC) with 120 mA output current sink capability. It is intended for driving voice coil actuators in applications such as lens autofocus, image stabilization, and optical zoom. The circuit diagram is shown in [Figure 20](#page-10-1). A 10-bit current output DAC coupled with Resistor R generates the voltage that drives the noninverting input of the operational amplifier. This voltage also appears across the RSENSE resistor and generates the sink current required to drive the voice coil.

Resistor R and Resistor RSENSE are interleaved and matched. Therefore, the temperature coefficient and any nonlinearities over temperature are matched, and the output drift over temperature is minimized. Diode D1 is an output protection diode.



#### Figure 20. Block Diagram Showing Connection to Voice Coil

### <span id="page-10-1"></span>**SERIAL INTERFACE**

The AD5821 is controlled using the industry-standard I<sup>2</sup>C 2-wire serial protocol. Data can be written to or read from the DAC at data rates of up to 400 kHz. After a read operation, the contents of the input register are reset to all 0s.

### **I <sup>2</sup>C BUS OPERATION**

<span id="page-10-2"></span>An I<sup>2</sup>C bus operates with one or more master devices that generate the serial clock (SCL) and read and write data on the serial data line (SDA) to and from slave devices such as the AD5821. All devices on an I<sup>2</sup>C bus have their SDA pin connected to the SDA line and their SCL pin connected to the SCL line of the master device. I<sup>2</sup>C devices can only pull the bus lines low; pulling high is achieved by pull-up resistors,  $R_P$ . The value of  $R_P$ depends on the data rate, bus capacitance, and the maximum load current that the I<sup>2</sup>C device can sink (3 mA for a standard device).



Figure 21. Typical  $l^2C$  Bus

When the bus is idle, SCL and SDA are both high. The master device initiates a serial bus operation by generating a start condition, which is defined as a high-to-low transition on the SDA low while SCL is high. The slave device connected to the bus responds to the start condition and shifts in the next eight data bits under control of the serial clock. These eight data bits consist of a 7-bit address, plus a read/write  $(R/\overline{W})$  bit that is 0 if data is to be written to a device, and 1 if data is to be read from a device. Each slave device on an I<sup>2</sup>C bus must have a unique address. The address of the AD5821 is 0001100; however, 0001101, 0001110, and 0001111 address the part because the last two bits are unused/don't cares (see [Figure 22](#page-11-1) and [Figure 23](#page-11-2)). Because the address plus the R/W bit always equals eight bits of data, the write address of the AD5821 is 00011000 (0x18) and the read address is 00011001 (0x19) (see [Figure 22](#page-11-1) and [Figure 23](#page-11-2)).

At the end of the address data, after the  $R/\overline{W}$  bit, the slave device that recognizes its own address responds by generating an acknowledge (ACK) condition. This is defined as the slave device pulling SDA low while SCL is low before the ninth clock pulse and keeping it low during the ninth clock pulse. Upon receiving ACK, the master device can clock data into the AD5821 in a write operation, or it can clock it out in a read operation. Data must change either during the low period of the clock (because SDA transitions during the high period define a start condition, as described previously), or during a stop condition, as described in the [Data Format](#page-10-2) section.

I <sup>2</sup>C data is divided into blocks of eight bits, and the slave generates an ACK at the end of each block. Because the AD5821 requires 10 bits of data, two data-words must be written to it when a write operation occurs, or read from it when a read operation occurs. At the end of a read or write operation, the AD5821 acknowledges the second data byte. The master generates a stop condition, defined as a low-to-high transition on SDA while SCL is high, to end the transaction.

### **DATA FORMAT**

Data is written to the AD5821 high byte first, MSB first, and is shifted into the 16-bit input register. After all data is shifted in, data from the input register is transferred to the DAC register.

Because the DAC requires only 10 bits of data, not all bits of the input register data are used. The MSB is reserved for an activehigh, software-controlled, power-down function. Bit 14 is unused; Bit 13 to Bit 4 correspond to the DAC data bits, Bit 9 to Bit 0. Bit 3 to Bit 0 are unused.

During a read operation, data is read in the same bit order.

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### <span id="page-11-2"></span>**Table 6. Data Format[1](#page-15-15)**



 $1$  XSHUTDOWN = soft power-down;  $X =$  unused/don't care; and D9 to D0 = DAC data.

### **POWER SUPPLY BYPASSING AND GROUNDING**

When accuracy is important in an application, it is beneficial to consider power supply and ground return layout on the PCB. The PCB for the AD5821 should have separate analog and digital power supply sections. Where shared AGND and DGND is necessary, the connection of grounds should be made at only one point, as close as possible to the AD5821.

<span id="page-11-3"></span>Special attention should be paid to the layout of the AGND return path and, and it should be tracked between the voice coil motor and ISINK to minimize any series resistance. [Figure 24](#page-11-3) shows the output current sink of the AD5821 and illustrates the importance of reducing the effective series impedance of AGND and the track resistance between the motor and ISINK. The voice coil is modeled as Inductor  $L_C$  and Resistor  $R_C$ . The current through the voice coil is effectively a dc current that results in a voltage drop,  $V_c$ , when the AD5821 is sinking current. The effect of any series inductance is minimal.



Figure 24. Effect of PCB Trace Resistance and Inductance

When sinking the maximum current of 120 mA, the maximum voltage drop allowed across  $R_{\tt SENSE}$  is 400 mV, and the minimum drain to source voltage of Q1 is 200 mV. This means that the AD5821 output has a compliance voltage of 600 mV. If  $V_{\text{DROP}}$ falls below 600 mV, the output transistor, Q1, can no longer operate properly and I<sub>SINK</sub> may not be maintained as a constant.

When sinking 90 mA, the maximum voltage drop allowed across R<sub>SENSE</sub> is 300 mV, and the minimum drain to source voltage of Q1 is 180 mV. This means that the AD5821 output has a compliance voltage of 480 mV. If V<sub>DROP</sub> falls below 480 mV, the output transistor, Q1, can no longer operate properly and  $I_{\text{SINK}}$  may not be maintained as a constant. As  $I_{\text{SINK}}$  decreases, the voltage required across the transistor, Q1, also decreases and, therefore, lower supplies can be used with the voice coil motor.

As the current increases to 120 mA through the voice coil,  $V<sub>C</sub>$  increases.  $V<sub>DROP</sub>$  decreases and eventually approaches the minimum specified compliance voltage of 600 mV (or 480 mV, if  $I_{\text{SINK}} = 90 \text{ mA}$ ). The ground return path is modeled by the components  $R_G$  and  $L_G$ . The track resistance between the voice coil and the AD5821 is modeled as RT. The inductive effects of L<sub>G</sub> influence R<sub>SENSE</sub> and R<sub>C</sub> equally, and because the current is maintained as a constant, it is not as critical as the purely resistive component of the ground return path. When the maximum sink current is flowing through the motor, the resistive elements,  $R_T$  and RG, may have an impact on the voltage headroom of Q1 and could, in turn, limit the maximum value of  $R_C$  because of voltage compliance.

For example, if

 $V_{BATTERY} = 3.6 V$  $R_G = 0.5 \Omega$  $R_T = 0.5 \Omega$  $I_{SINK} = 120$  mA  $V_{DROP} = 600$  mV (the compliance voltage)

Then the largest value of resistance of the voice coil, Rc, is

$$
R_{C} = \frac{V_{BAT} - [V_{DROP} + (I_{SINK} \times R_{T}) + (I_{SINK} \times R_{G})]}{I_{SINK}} =
$$

 $\frac{(3.6 \text{ V} - [600 \text{ mV} + 2 \times (120 \text{ mA} \times 0.5 \Omega)]}{120 \text{ A}} = 24 \Omega$  $120 \text{ mA}$ 

Using another example, if

 $V<sub>BATTERY</sub> = 3.6 V$  $R_G = 0.5 \Omega$  $R_T = 0.5 \Omega$  $I_{\text{SINK}} = 90 \text{ mA}$ 

 $V_{DROP} = 480$  mV (the compliance voltage specification at 90 mA)

Then the largest value of resistance of the voice coil, R<sub>C</sub>, is

$$
R_C = \frac{V_{BAT} - [V_{DROP} + (I_{SINK} \times R_T) + (I_{SINK} \times R_G)]}{I_{SINK}} =
$$
  
3.6 V - [480 mV + 2 × (90 mA × 0.5 Ω)]  
90 mA = 3.66 Ω

For this reason, it is important to minimize any series impedance on both the ground return path and interconnect between the AD5821 and the motor. It is also important to note that for lower values of I<sub>SINK</sub>, the compliance voltage of the output stage also decreases. This decrease allows the user to either use voice coil motors with high resistance values or decrease the power supply voltage on the voice coil motor. The compliance voltage decreases as the I<sub>SINK</sub> current decreases.

The power supply of the AD5821, or the regulator used to supply the AD5821, should be decoupled. Best practice power supply decoupling recommends that the power supply be decoupled with a 10 μF capacitor. Ideally, this 10 μF capacitor should be of a tantalum bead type. However, if the power supply or regulator supply is well regulated and clean, such decoupling may not be required. The AD5821 should be decoupled locally with a 0.1 μF ceramic capacitor, and this 0.1 μF capacitor should be located as close as possible to the  $V_{DD}$  pin. The 0.1  $\mu$ F capacitor should be ceramic with a low effective series resistance and effective series inductance. The 0.1 μF capacitor provides a low impedance path to ground for high transient currents.

The power supply line should have as large a trace as possible to provide a low impedance path and reduce glitch effects on the supply line. Clocks and other fast switching digital signals should be shielded from other parts of the board by digital ground. Avoid crossover of digital and analog signals, if possible. When traces cross on opposite sides of the board, they should run at right angles to each other to reduce feedthrough effects through the board. The best technique is to use a multilayer board with ground and power planes, where the component side of the board is dedicated to the ground plane only and the signal traces are placed on the solder side. However, this is not always possible with a 2-layer board.

### <span id="page-13-0"></span>APPLICATIONS INFORMATION

The AD5821 is designed to drive both spring-preloaded and nonspring linear motors used in applications such as lens autofocus, image stabilization, or optical zoom. The operation principle of the spring-preloaded motor is that the lens position is controlled by the balancing of a voice coil and spring. Figure 25 shows the transfer curve of a typical spring-preloaded linear motor for autofocus. The key points of this transfer function are displacement or stroke, which is the actual distance the lens moves in millimeters (mm) and the current through the motor, measured in milliamps (mA).

A start current is associated with spring-preloaded linear motors, which is a threshold current that must be exceeded for any displacement in the lens to occur. The start current is usually 20 mA or greater; the rated stroke or displacement is usually 0.25 mm to 0.4 mm; and the slope of the transfer curve is approximately 10 μm/mA or less.

The AD5821 is designed to sink up to 120 mA, which is more than adequate for available commercial linear motors or voice coils. Another factor that makes the AD5821 the ideal solution for these applications is the monotonicity of the device, ensuring that lens positioning is repeatable for the application of a given digital word.

[Figure 26](#page-13-1) shows a typical application circuit for the AD5821.



Figure 25. Spring-Preloaded Voice Coil Stroke vs. Sink Current

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#### <span id="page-13-1"></span>Figure 26. Typical Application Circuit

# <span id="page-14-0"></span>OUTLINE DIMENSIONS



(CB-9-1) Dimensions shown in millimeters

### **ORDERING GUIDE**

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 $1 Z = Pb$ -free part.

### <span id="page-15-14"></span><span id="page-15-13"></span><span id="page-15-9"></span><span id="page-15-8"></span><span id="page-15-7"></span>**NOTES**

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